



SANYO Semiconductors

DATA SHEET

LV5710GP — Bi-CMOS LSI For camera sensor Power supply for charge pump

Overview

The LV5710GP is power supply for charge pump for camera sensor.

Functions

- Regulating the 5V input by boosting it three-fold with the charge pump to the specified voltage.
- Output voltage variable with external resistor.
- Soft start function incorporated, which reduces the rush current at start of charge pump.
- Timer-latch type short-circuit protective function incorporated.

Specifications

Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	$V_{DD\ max}$		6.0	V
Allowable power dissipation	$P_d\ max$	with specified substrate *	0.55	W
Operating temperature	T_{opr}		-20 to +80	$^\circ\text{C}$
Storage temperature	T_{stg}		-40 to +125	$^\circ\text{C}$

* : Specified substrate : 114.3mm×76.1mm×1.6mm, glass epoxy board

Allowable Operating Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Supply voltage	V_{DD}		4.5		5.5	V
Input "H" voltage	V_{INH}	EN pin	1.5		V_{DD}	V
Input "L" voltage	V_{INL}	EN pin	-0.1		0.4	V

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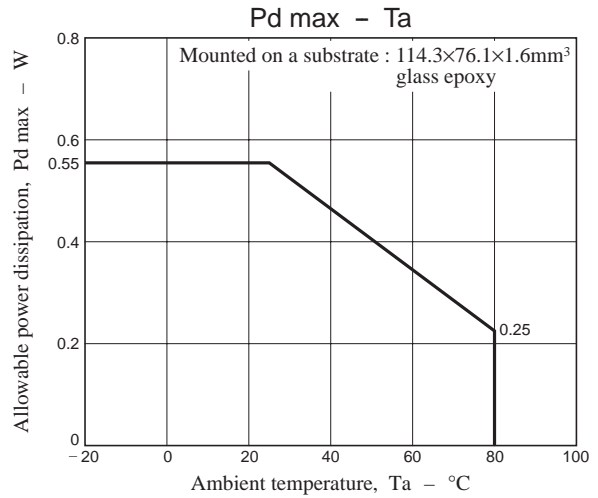
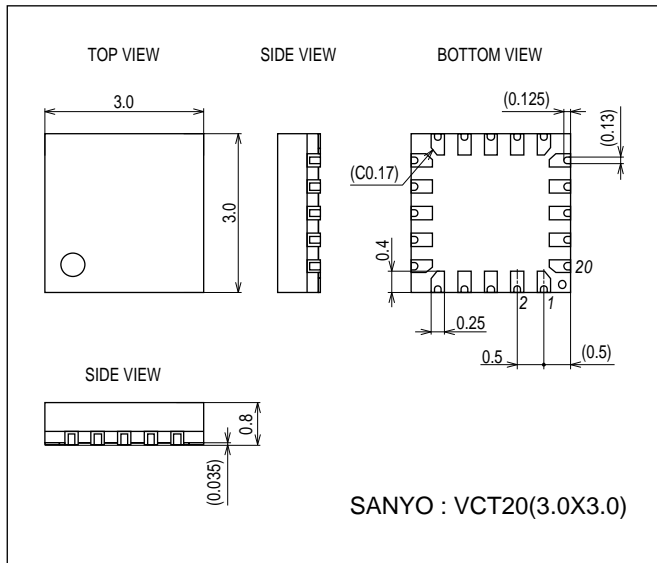
Electrical Characteristics at $T_a = 25^\circ\text{C}$, $V_{DD} = 5\text{V}$, $I_{OUT} = 30\text{mA}$, $S0 = L$, $S1 = L$, Unless otherwise specified

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Circuit current drain	I_{DD1}	EN = L			1	μA
	I_{DD2}	EN = H No load		12	18	mA
Output load current	$I_{O\text{ ave}}$	At $V_{OUT} = 12\text{V}$ setting			30	mA
Reference voltage	V_{REF}	$V_{DD} = 4.5$ to 5.5V	1.285	1.305	1.325	V
		$T_a = -20^\circ\text{C}$ to $+80^\circ\text{C}$, Design value	1.279		1.331	V
Output voltage at OFF	V_{OFF}	After capacitive discharge	-50	0	50	mV
Protective circuit masking time	T_{mask}	Masking time from detection of short-circuit to IC OFF		18	33	ms
Short-circuit protective current	I_{lim}		35	50	65	mA
Short-circuit protective voltage	V_{lim}		82.5	87.5	92.5	%
SS end time	$T_{SS\text{ END}}$	Time from EN = H to regulator SS OFF $T_a = -20^\circ\text{C}$ to $+80^\circ\text{C}$ Design value			10	ms
RO load regulation	ΔRO	Load $1\text{mA} \rightarrow 30\text{mA}$		30	40	mV
Input pin current	I_{in}	Pins EN	30	40	50	μA
		S0 and S1 pins			1	μA
Power efficiency	P_{eff}	CP+regulator		70		%
Rush current	I_{rush}	No load			300	mA
Oscillation frequency	f_{clk}		1.4	1.8	2.3	MHz

Package Dimensions

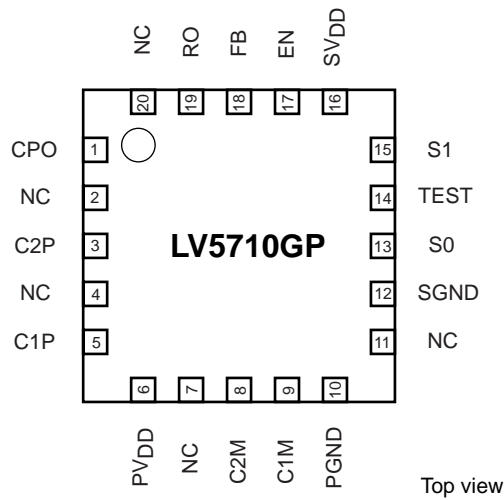
unit : mm (typ)

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Pin Assignment

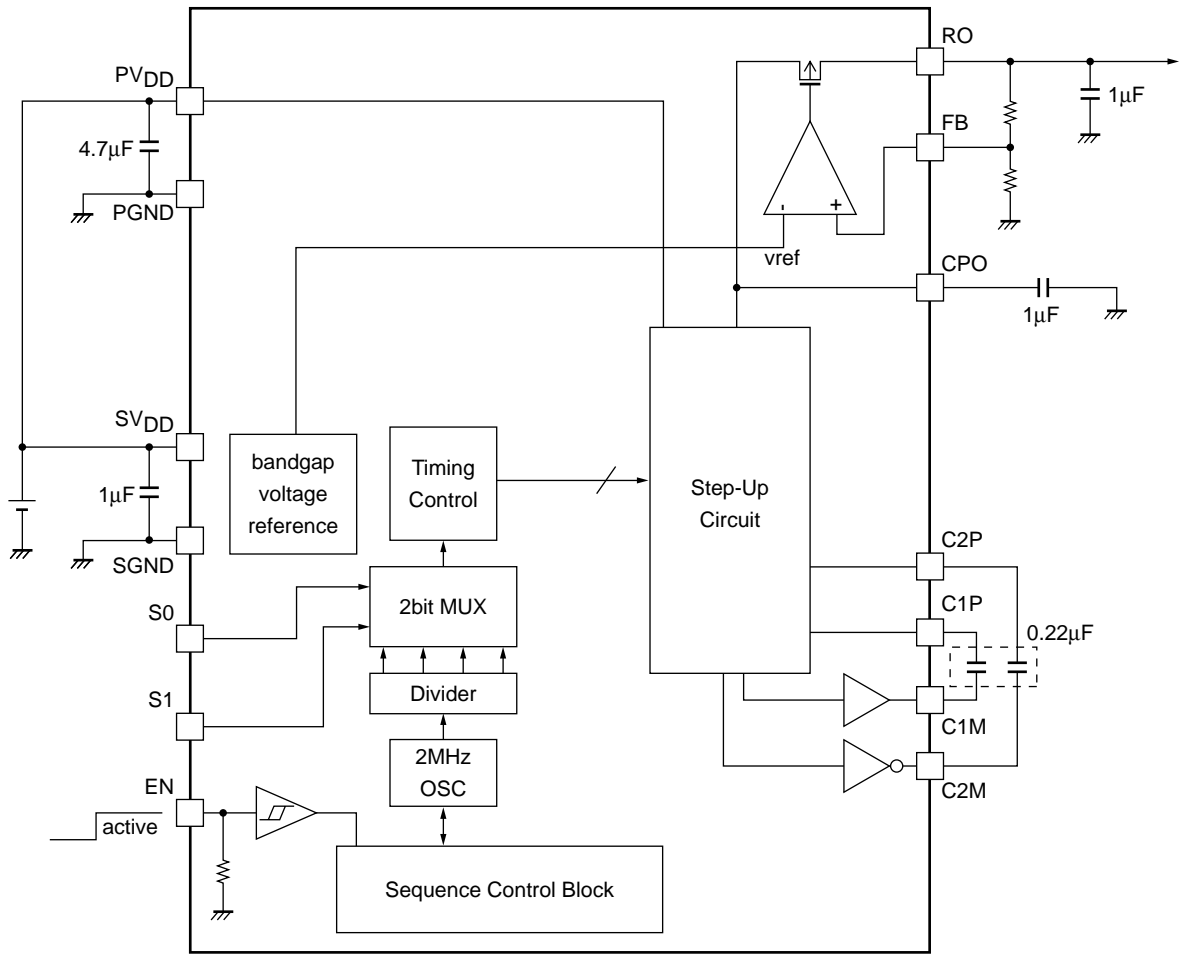


Pin Function

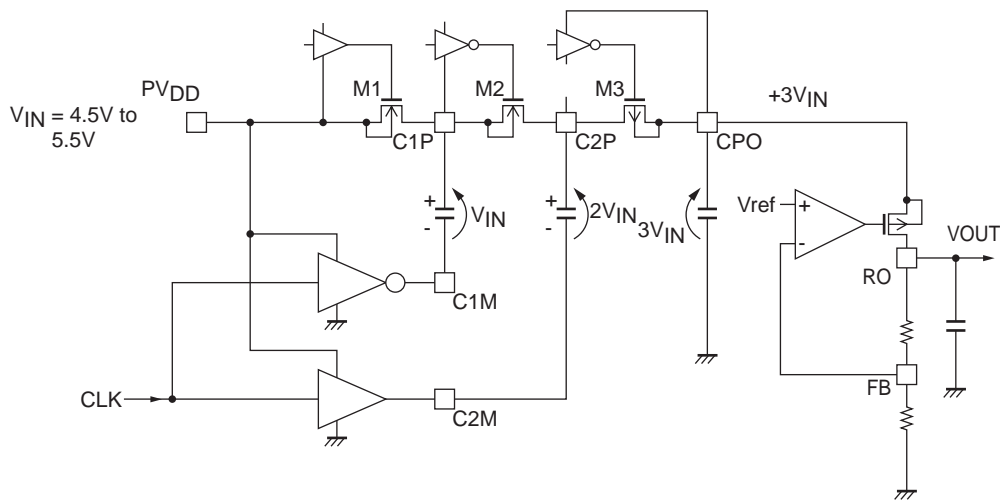
Pin No.	Name	Function
1	CPO	Boost voltage output (6V _{DD} or 5V _{DD})
2	NC	
3	C2P	Boost capacitor connection pin (charge transfer side)
4	NC	
5	C1P	Boost capacitor connection pin (charge transfer side)
6	PV _{DD}	Power system V _{DD} pin
7	NC	
8	C2M	Boost capacitor connection pin (driver side)
9	C1M	Boost capacitor connection pin (driver side)
10	PGND	Power GND pin for the charge pump
11	NC	
12	SGND	Small signal system GND pin
13	S0	Charge pump frequency changeover pin
14	TEST	Test pin (open or short-circuited to GND)
15	S1	Charge pump frequency changeover pin
16	SV _{DD}	Small signal system V _{DD} pin
17	EN	System enable pin (Hi active)
18	FB	Regulator FB pin
19	RO	Regulator output pin
20	NC	

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Block Diagram



Equivalent Circuit Diagram

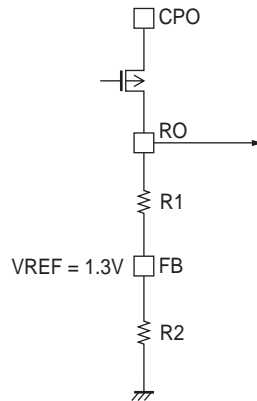


Output Voltage Setting Method

The output voltage of IC-incorporated LDO can be determined as follows :

$$V_H = \frac{R1+R2}{R2} \times V_{REF}$$

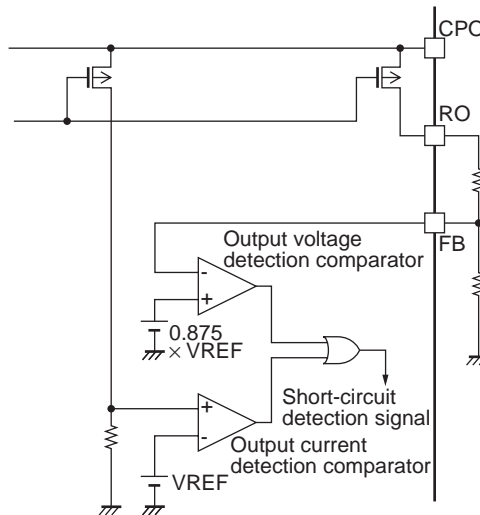
For example, to set the output voltage to 12V, set the resistance Value to $R1 = 1070k\Omega/R2 = 130k\Omega$.



Short-circuit Protective Operation

The RO output pin has the short-circuit protective function.

The over-current detector circuit outputs the detection signal when the output current of 50mA (typ) or more flows or when the output voltage drops below 87.5% (typ). When this detection signal is output continuously for 18ms (typ) or more, IC determines that there is over-current and stops the output. To reset from the stop state, set the EN pin to “L”, then set the EN pin to “H” again.



Equivalent circuit of the over-current detection circuit

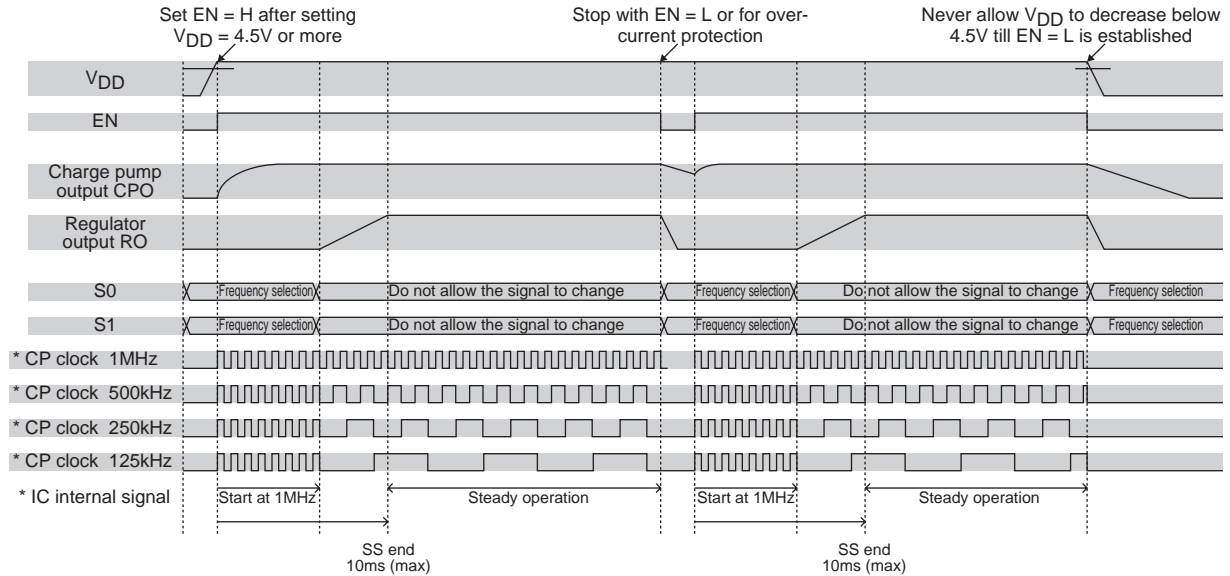
Selecting the Frequency

According to the logic of S0 and S1, the charge pump operation frequency can be changed.

In the case of light load, the reactive power can be reduced by decreasing the operating frequency.

S0	S1	CP operating frequency
L	L	1MHz
H	L	500kHz
L	H	250kHz
H	H	125kHz

Startup sequence



EN Pin and VDD

The sequence operation is made at startup. However, startup is not made when the internal circuit has not been reset. To reset the internal circuit, keep the EN pin to "L" till VDD becomes 4.5V or more. Note that VDD and EN pin cannot be short-circuited for this purpose.

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